

Declaration and Power of Attorney

As below-named inventors, we hereby declare that:

Our residences, post office addresses, and citizenships are as stated below next to our names.

We believe that we are the original, first and joint inventors of the subject matter which is claimed and for which a patent is sought on the invention entitled **Method for Rapid Thermal Processing of Substrates** (File No. 03371-P0005A LHR), the specification of which is attached hereto.

We hereby state that we have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. To the best of our knowledge, information, and belief the facts stated therein are true.

We acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

We hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign applications for patent or inventor's certificate listed below and have also identified below any foreign applications for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

None

We hereby claim the benefit under Title 35, United States Code, §120 of the following United States Applications listed below, and insofar as the subject matter of each of the claims of this Application is not disclosed in the prior United States Application in the manner provided by the first paragraph of Title 35, United States Code, §112, we acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

United States Application No. 09/ filed October 12, 2000

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Declaration and Power of Attorney
Lynn David Bollinger, t al.

I hereby claim the priority benefits under Title 35, United States Code §119(e) of the following United States provisional application(s) listed below:

United States Application No. 60/162,764 Filed November 1, 1999 and
United States Application for "Method Of Rapid Thermal Processing Substrates Using Gas Heating To Obtain Very Rapid Heating And Cool-Down With Control Of The Temperature Profile Across The Substrate Thickness" filed in July, 2000
by Lynn David Bollinger and Iskander Tokmouline

We hereby declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

We hereby appoint Louis H. Reens, Registration No. 22,588, of ST.ONGE STEWARD JOHNSTON & REENS LLC; 986 Bedford Street; Stamford, Connecticut 06905-5619 (203 324-6155); with full power of substitution, association and revocation, as attorney to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith.

Please direct all telephone calls and correspondence to Louis H. Reens at the above address and telephone number.

Full name of first inventor:

Lynn David Bollinger

Inventor's signature



Date:

October 18, 2000

Residence:

Ridgefield, Connecticut

Citizenship:

A citizen of the United States

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[illegible]

Iskander Tokmouline

October 2000

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